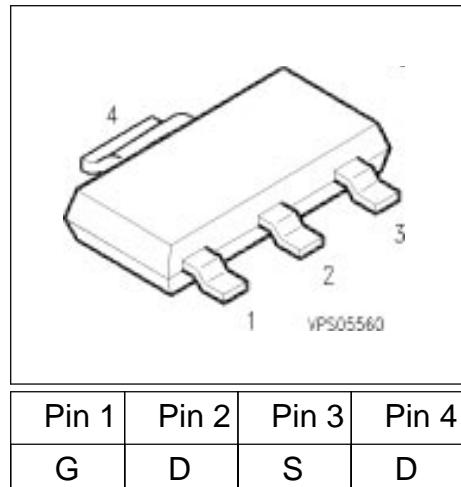


SIPMOS® Small-Signal Transistor

- N channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = 0.8\ldots2.0V$



Type	V_{DS}	I_D	$R_{DS(on)}$	Package	Marking
BSP 89	240 V	0.36 A	6 Ω	SOT-223	BSP 89
Type	Ordering Code		Tape and Reel Information		
BSP 89	Q67000-S652		E6327		

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain source voltage	V_{DS}	240	V
Drain-gate voltage	V_{DGR}	240	
$R_{GS} = 20 \text{ k}\Omega$			
Gate source voltage	V_{GS}	± 14	
Gate-source peak voltage, aperiodic	V_{gs}	± 20	
Continuous drain current	I_D	0.36	A
$T_A = 29^\circ\text{C}$			
DC drain current, pulsed	I_{Dpuls}	1.44	
$T_A = 25^\circ\text{C}$			
Power dissipation	P_{tot}	1.7	W
$T_A = 25^\circ\text{C}$			

Maximum Ratings

Parameter	Symbol	Values	Unit
Chip or operating temperature	T_j	-55 ... + 150	°C
Storage temperature	T_{stg}	-55 ... + 150	
Thermal resistance, chip to ambient air	R_{thJA}	≤ 72	K/W
Thermal resistance, junction-soldering point ¹⁾	R_{thJS}	≤ 12	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm² copper area for drain connection

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}, T_j = 25^\circ\text{C}$	$V_{(\text{BR})DSS}$	240	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	$V_{GS(\text{th})}$	0.8	1.5	2	
Zero gate voltage drain current $V_{DS} = 240 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25^\circ\text{C}$ $V_{DS} = 240 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125^\circ\text{C}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25^\circ\text{C}$	I_{DSS}	- - -	0.1 10 -	1 100 0.2	μA
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	I_{GSS}	-	10	100	nA
Drain-Source on-state resistance $V_{GS} = 10 \text{ V}, I_D = 0.36 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 0.36 \text{ A}$	$R_{DS(\text{on})}$	- -	3.5 4	6 10	Ω

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 0.36 \text{ A}$	g_{fs}	0.14	0.36	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	80	110	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	15	25	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	8	12	
Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(on)}$	-	5	8	ns
Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_{GS} = 50 \Omega$	t_r	-	10	15	
Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(off)}$	-	30	40	
Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 0.28 \text{ A}$ $R_{GS} = 50 \Omega$	t_f	-	20	27	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

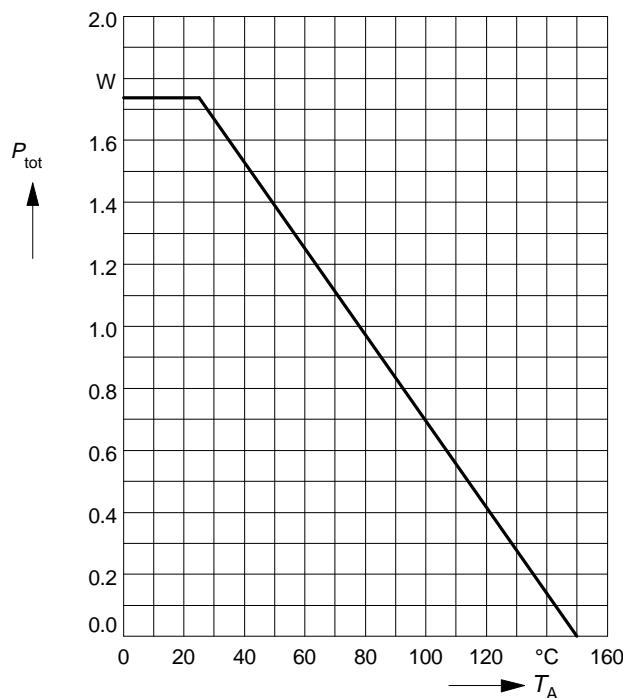
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	I_S	-	-	0.36	A
Inverse diode direct current,pulsed $T_A = 25^\circ\text{C}$	I_{SM}	-	-	1.44	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 0.72 \text{ A}, T_j = 25^\circ\text{C}$	V_{SD}	-	1.1	1.4	V

Power dissipation

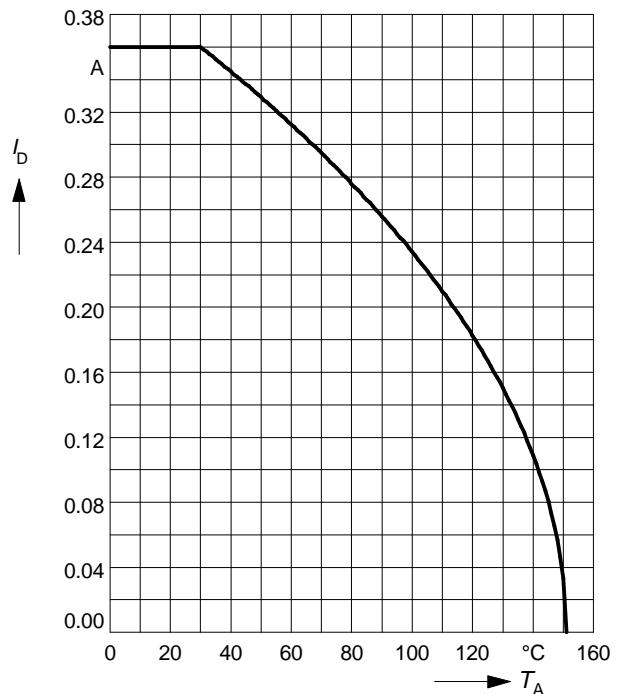
$$P_{\text{tot}} = f(T_A)$$



Drain current

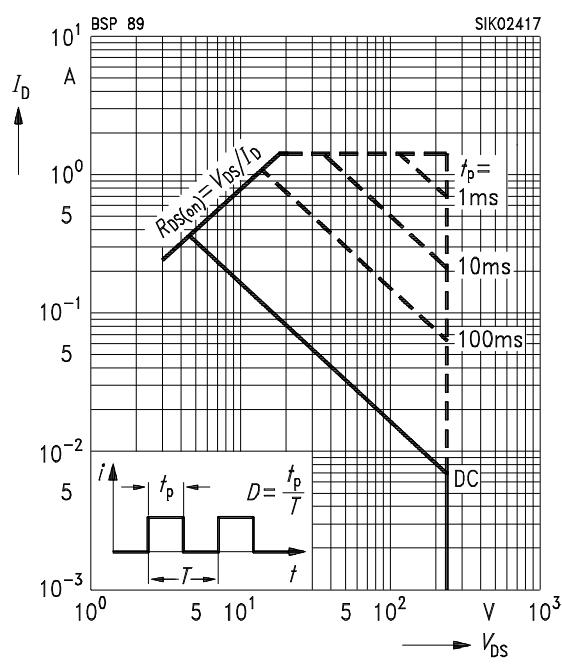
$$I_D = f(T_A)$$

parameter: $V_{GS} \geq 10$ V



Safe operating area $I_D=f(V_{DS})$

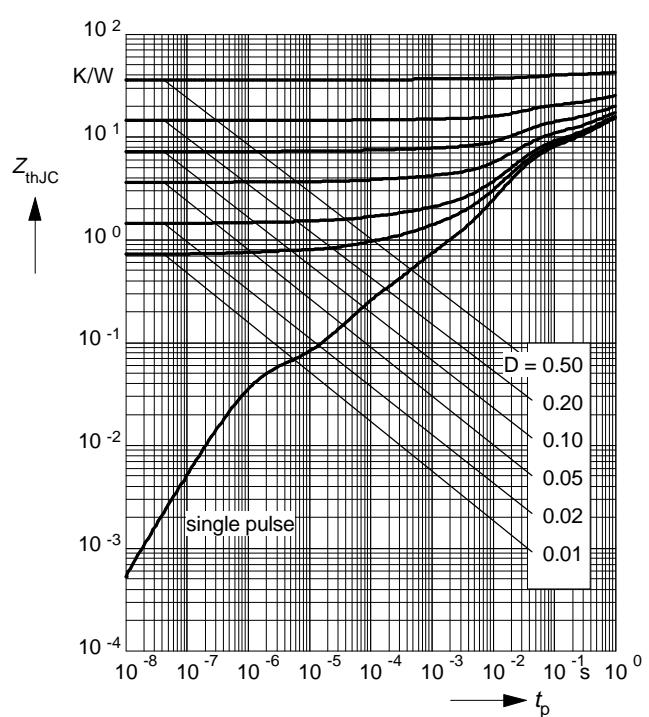
parameter : $D = 0$, $T_C=25^\circ\text{C}$



Transient thermal impedance

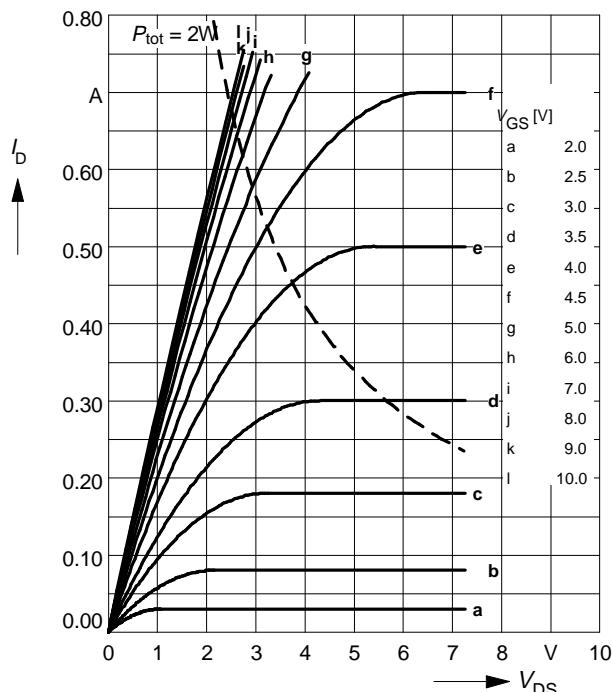
$$Z_{\text{th JA}} = f(t_p)$$

parameter: $D = t_p / T$



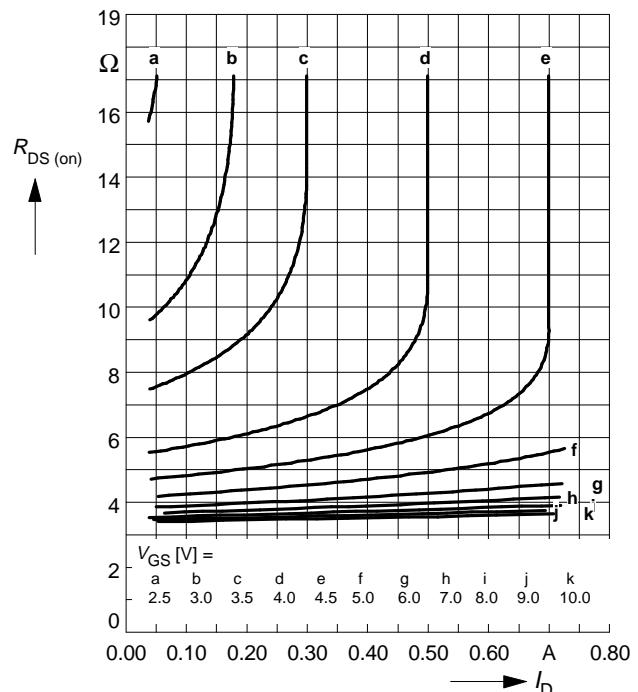
Typ. output characteristics

$I_D = f(V_{DS})$
parameter: $t_p = 80 \mu\text{s}$

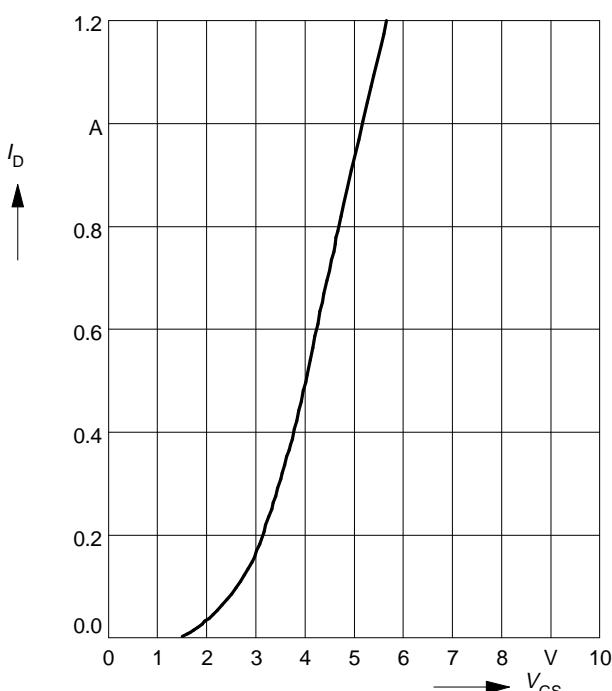


Typ. drain-source on-resistance

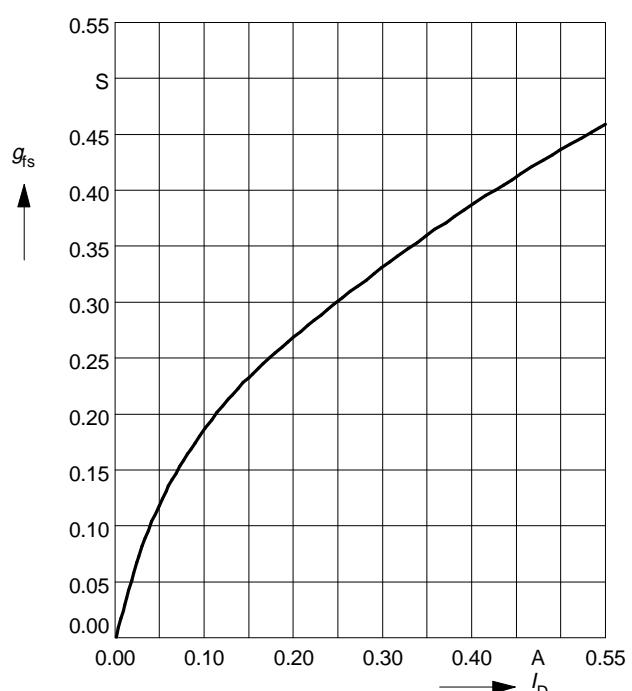
$R_{DS(on)} = f(I_D)$
parameter: $t_p = 80 \mu\text{s}, T_j = 25^\circ\text{C}$



Typ. transfer characteristics $I_D = f(V_{GS})$
parameter: $t_p = 80 \mu\text{s}$



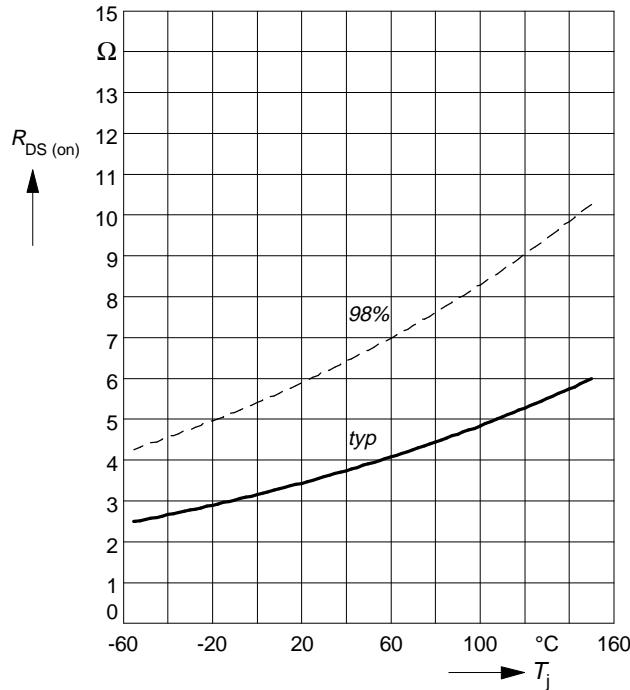
Typ. forward transconductance $g_{fs} = f(I_D)$
parameter: $t_p = 80 \mu\text{s},$



Drain-source on-resistance

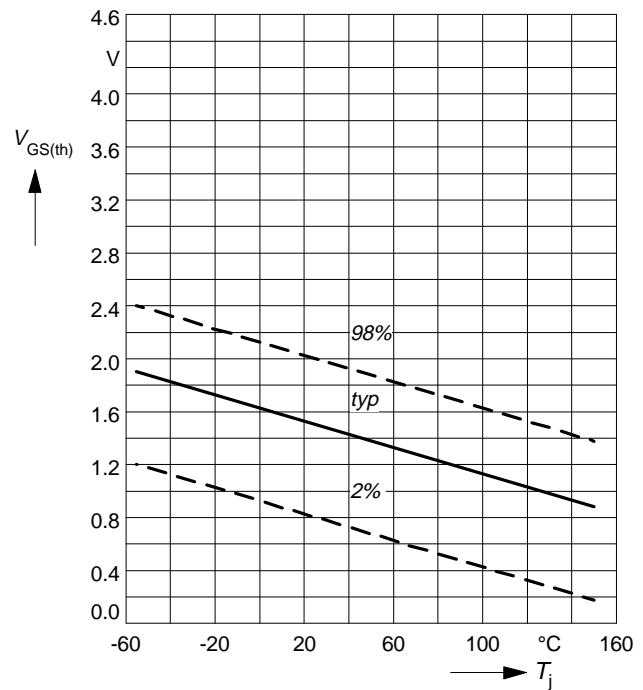
$$R_{DS(on)} = f(T_j)$$

parameter: $I_D = 0.36 \text{ A}$, $V_{GS} = 10 \text{ V}$


Gate threshold voltage

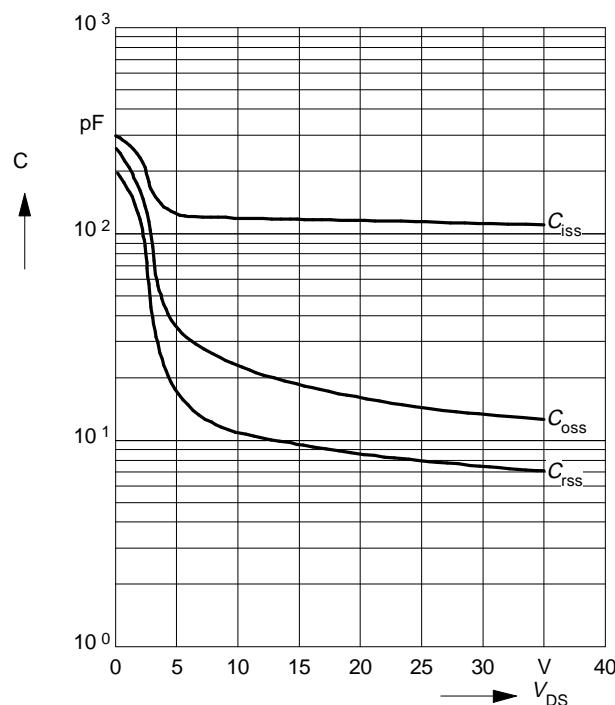
$$V_{GS(th)} = f(T_j)$$

parameter: $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$


Typ. capacitances

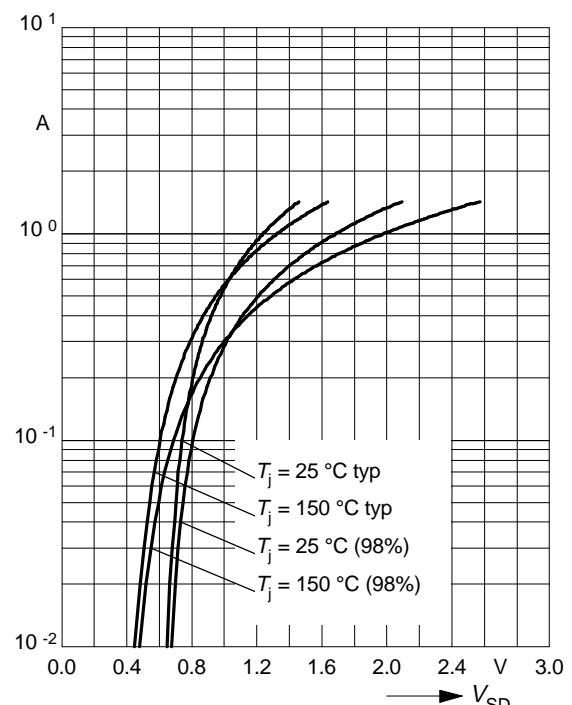
$$C = f(V_{DS})$$

parameter: $V_{GS}=0\text{V}$, $f = 1 \text{ MHz}$


Forward characteristics of reverse diode

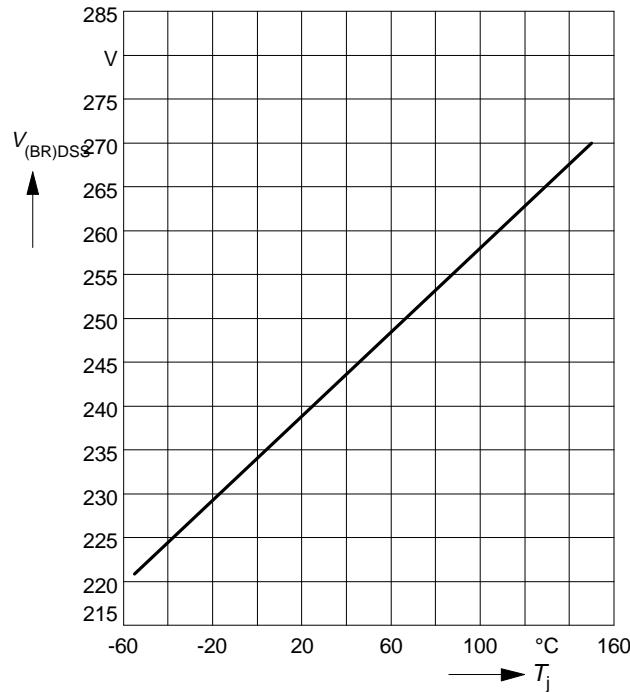
$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80 \mu\text{s}$



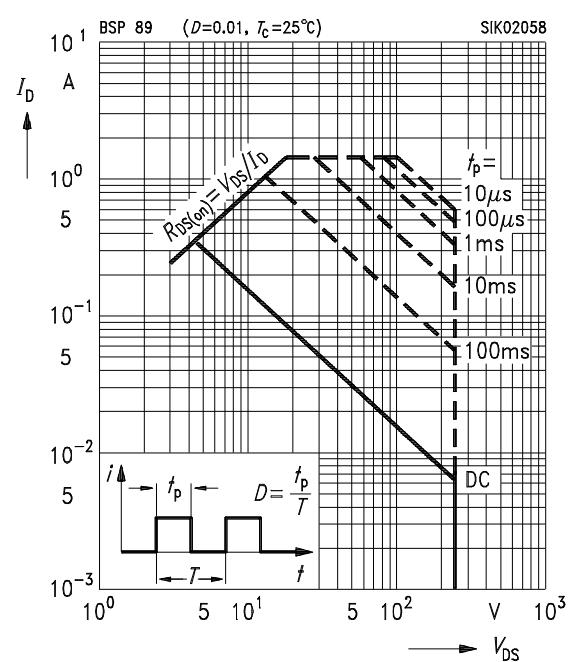
Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



Safe operating area $I_D=f(V_{DS})$

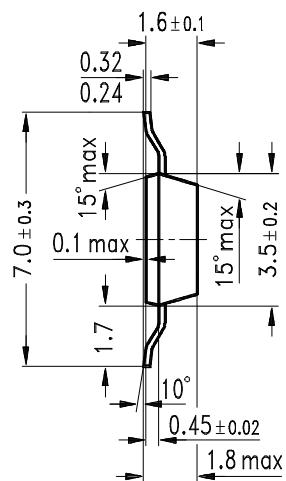
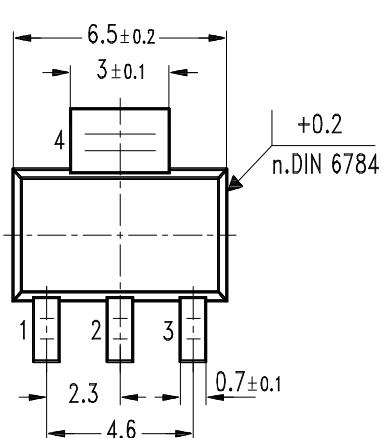
parameter : $D = 0.01$, $T_C=25^\circ\text{C}$



Package outlines

SOT-223

Dimensions in mm



GPS05560